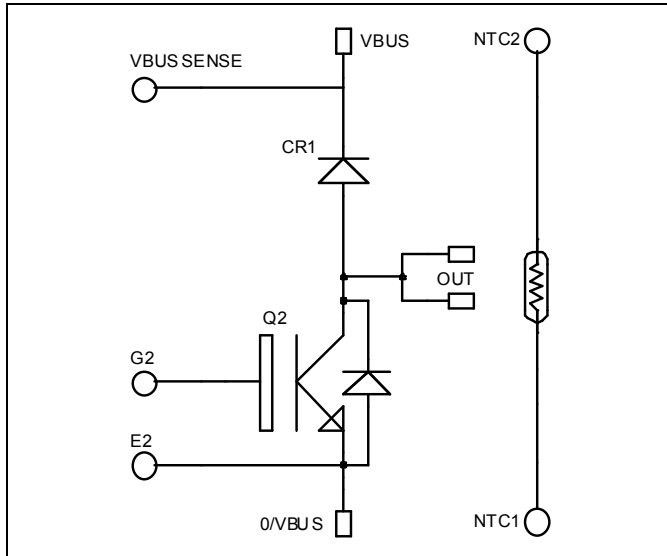


## Boost chopper NPT IGBT Power Module

**$V_{CES} = 1200V$   
 $I_C = 100A @ T_c = 80^\circ C$**

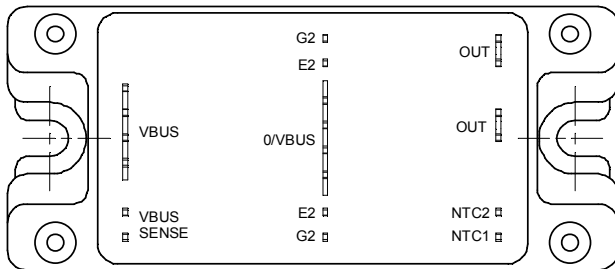


### Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

### Features

- Non Punch Through (NPT) FAST IGBT
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 50 kHz
  - Soft recovery parallel diodes
  - Low diode VF
  - Low leakage current
  - Avalanche energy rated
  - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
  - Symmetrical design
  - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration



### Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Easy paralleling due to positive TC of VCEsat
- Low profile

### Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
$V_{CES}$	Collector - Emitter Breakdown Voltage	1200	V
$I_C$	Continuous Collector Current	$T_c = 25^\circ C$	150
		$T_c = 80^\circ C$	100
$I_{CM}$	Pulsed Collector Current	$T_c = 25^\circ C$	300
$V_{GE}$	Gate - Emitter Voltage	$\pm 20$	V
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	568
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^\circ C$	300A @ 1200V

**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

## Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$BV_{CES}$	Collector - Emitter Breakdown Voltage	$V_{GE} = 0\text{V}, I_C = 750\ \mu\text{A}$	1200			V
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{GE} = 0\text{V}$ $V_{CE} = 1200\text{V}$			750 3750	$\mu\text{A}$
$V_{CE(on)}$	Collector Emitter on Voltage	$V_{GE} = 15\text{V}$ $I_C = 100\text{A}$		3.2 4.0	3.7	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 2\ \text{mA}$	4.5		6.5	V
$I_{GES}$	Gate - Emitter Leakage Current	$V_{GE} = 20\ \text{V}, V_{CE} = 0\text{V}$			150	nA

## Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit	
$C_{ies}$	Input Capacitance	$V_{GE} = 0\text{V}$		6900		$\text{pF}$	
$C_{oes}$	Output Capacitance	$V_{CE} = 25\text{V}$		660			
$C_{res}$	Reverse Transfer Capacitance	$f = 1\text{MHz}$		440			
$Q_g$	Total gate Charge	$V_{GS} = 15\text{V}$		660		nC	
$Q_{ge}$	Gate - Emitter Charge	$V_{Bus} = 600\text{V}$		70			
$Q_{gc}$	Gate - Collector Charge	$I_C = 100\text{A}$		400			
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching ( $25^\circ\text{C}$ ) $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ $I_C = 100\text{A}$ $R_G = 2.5\ \Omega$		35		ns	
$T_r$	Rise Time			65			
$T_{d(off)}$	Turn-off Delay Time			320			
$T_f$	Fall Time			30			
$E_{on}$	Turn-on Switching Energy ①				10.8		mJ
$E_{off}$	Turn-off Switching Energy ②				4.6		
$T_{d(on)}$	Turn-on Delay Time		Inductive Switching ( $125^\circ\text{C}$ ) $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ $I_C = 100\text{A}$ $R_G = 2.5\ \Omega$		35		ns
$T_r$	Rise Time				65		
$T_{d(off)}$	Turn-off Delay Time			360			
$T_f$	Fall Time			40			
$E_{on}$	Turn-on Switching Energy ①				13.9		mJ
$E_{off}$	Turn-off Switching Energy ②				6.1		

## Reverse diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle $T_c = 70^\circ\text{C}$		120		A
$V_F$	Diode Forward Voltage	$I_F = 120\text{A}$		2.0	2.5	V
		$I_F = 240\text{A}$		2.3		
		$I_F = 120\text{A}$	$T_j = 125^\circ\text{C}$		1.8	
$t_{rr}$	Reverse Recovery Time	$I_F = 120\text{A}$ $V_R = 800\text{V}$ $di/dt = 400\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$	400		ns
			$T_j = 125^\circ\text{C}$	470		
$Q_{rr}$	Reverse Recovery Charge	$I_F = 120\text{A}$ $V_R = 800\text{V}$ $di/dt = 400\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$	2400		nC
			$T_j = 125^\circ\text{C}$	8000		

①  $E_{on}$  includes diode reverse recovery

② In accordance with JEDEC standard JESD24-1

## Thermal and package characteristics

Symbol	Characteristic	Min	Typ	Max	Unit
R <sub>thJC</sub>	Junction to Case	IGBT		0.22	°C/W
		Diode		0.46	
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t=1 min, I isol<1mA, 50/60Hz	2500			V
T <sub>J</sub>	Operating junction temperature range	-40		150	°C
T <sub>STG</sub>	Storage Temperature Range	-40		125	
T <sub>C</sub>	Operating Case Temperature	-40		100	
Torque	Mounting torque	To Heatsink	M5		4.7 N.m
Wt	Package Weight			160	g

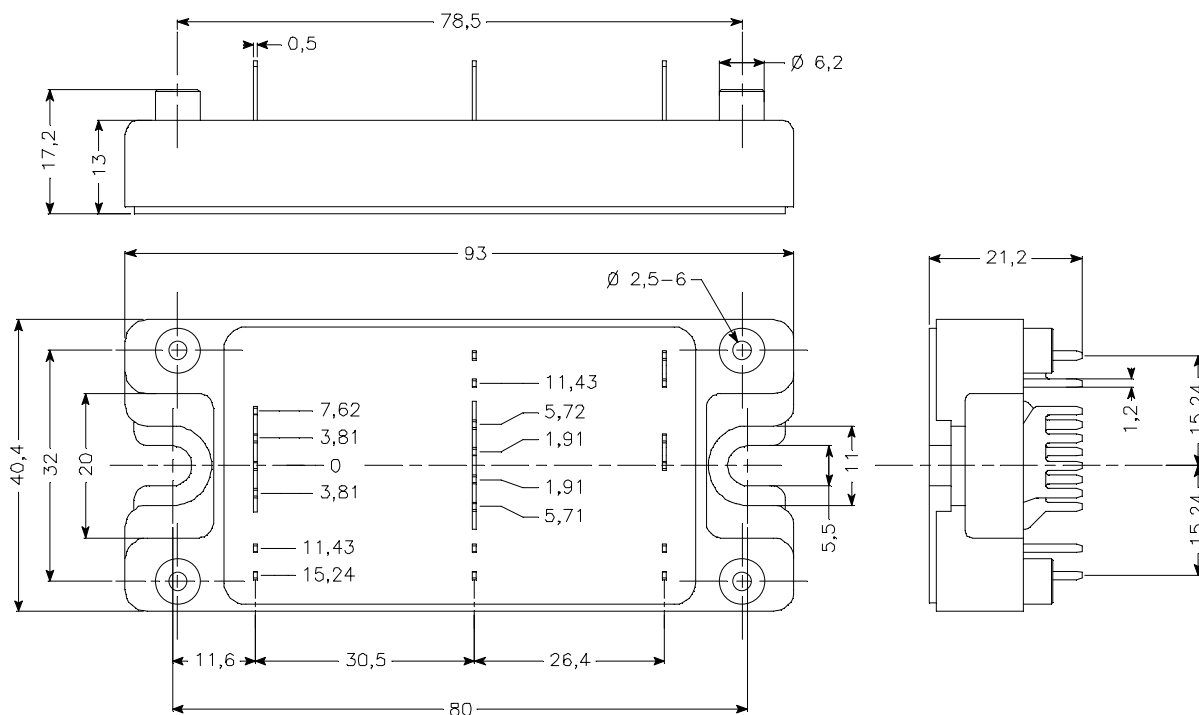
## Temperature sensor NTC

Symbol	Characteristic	Min	Typ	Max	Unit
R <sub>25</sub>	Resistance @ 25°C		68		kΩ
B <sub>25/85</sub>	T <sub>25</sub> = 298.16 K		4080		K

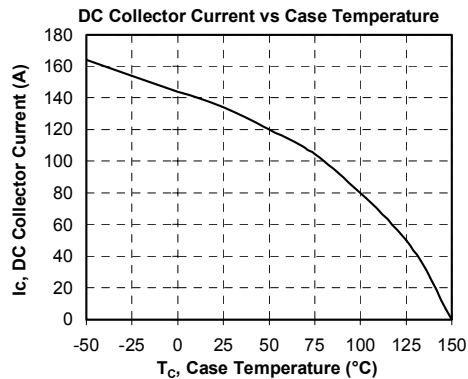
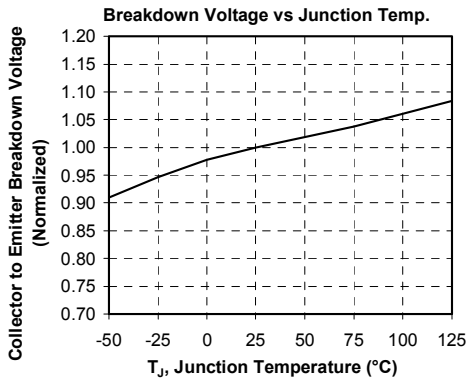
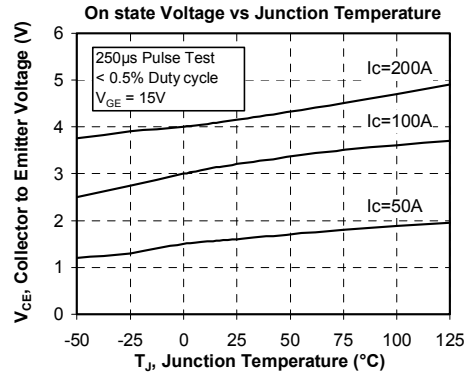
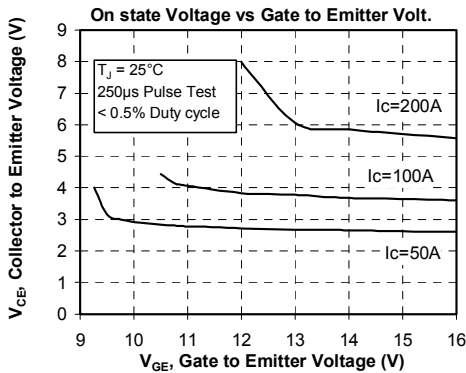
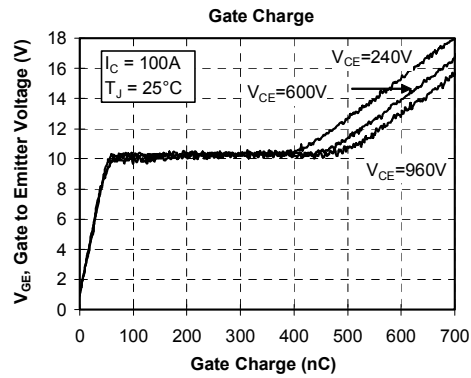
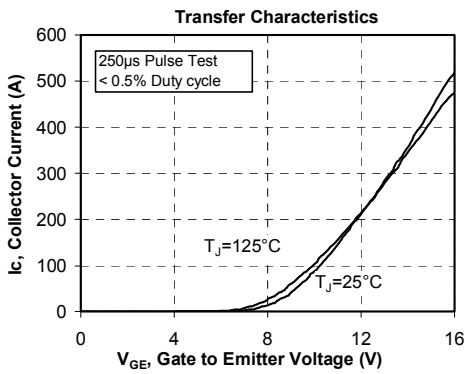
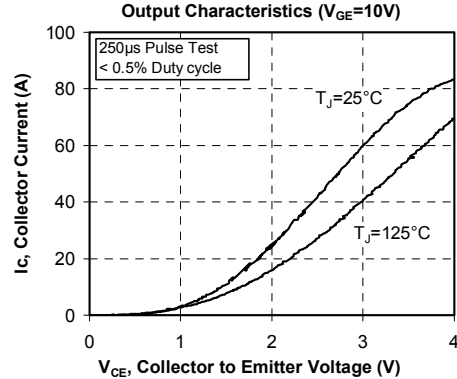
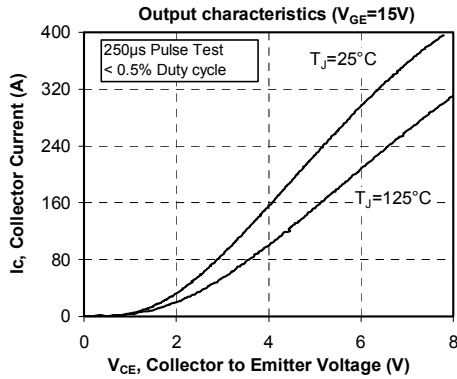
$$R_T = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

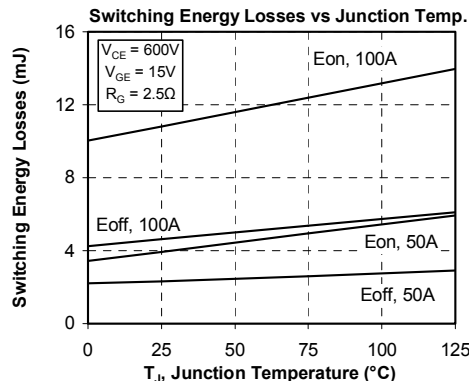
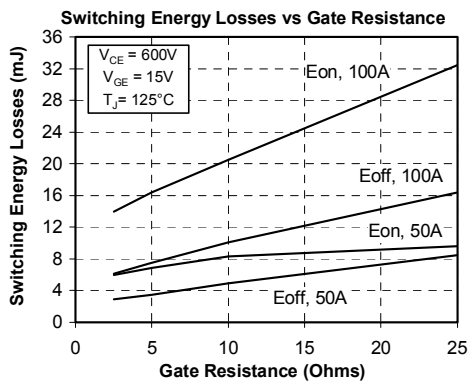
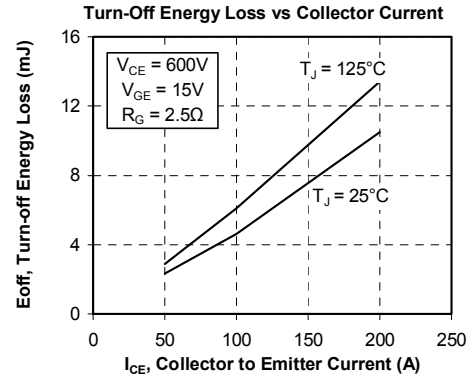
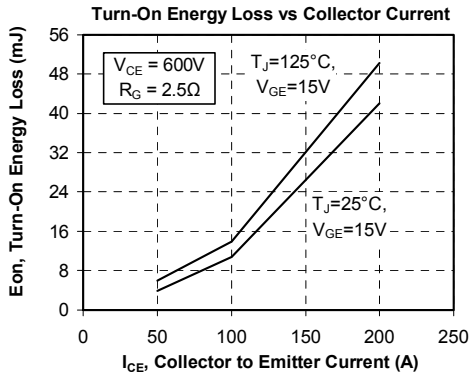
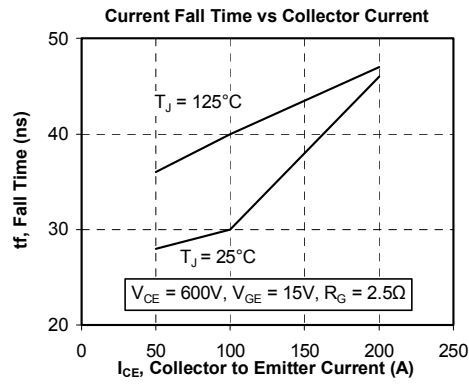
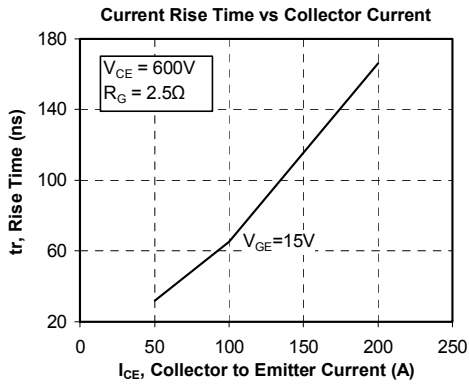
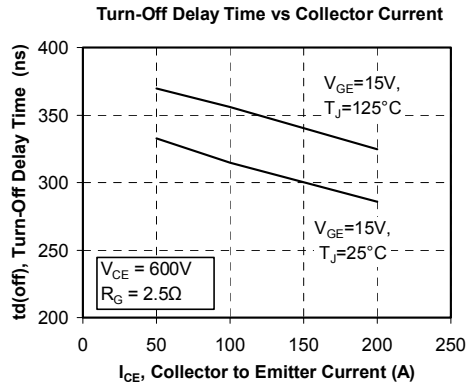
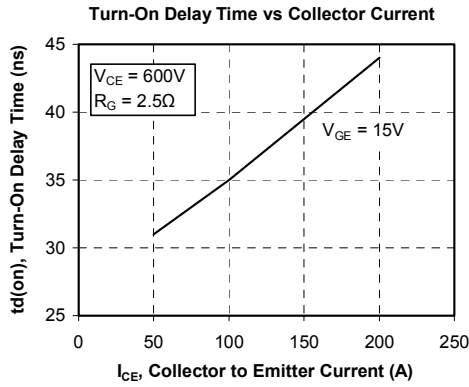
T: Thermistor temperature  
R<sub>T</sub>: Thermistor value at T

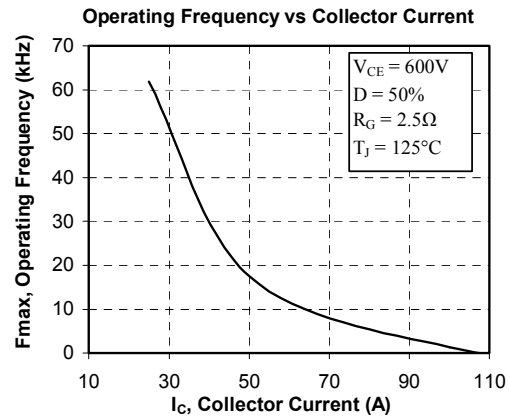
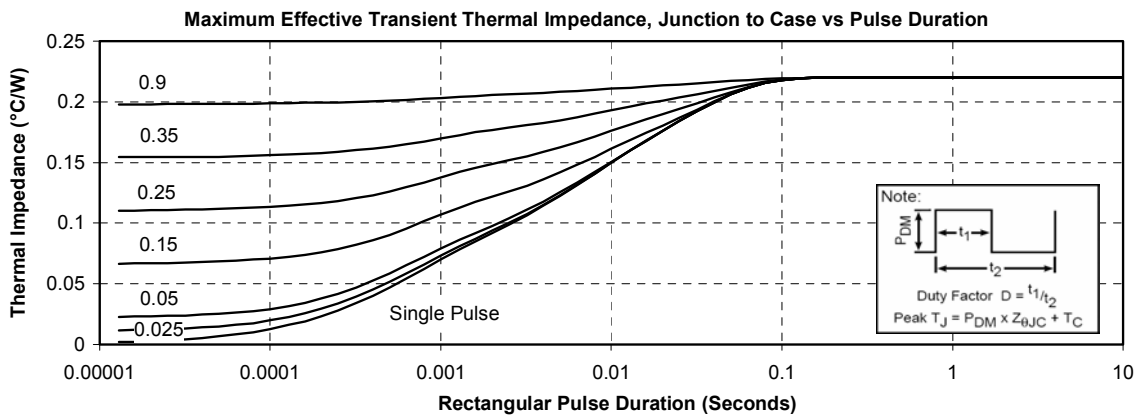
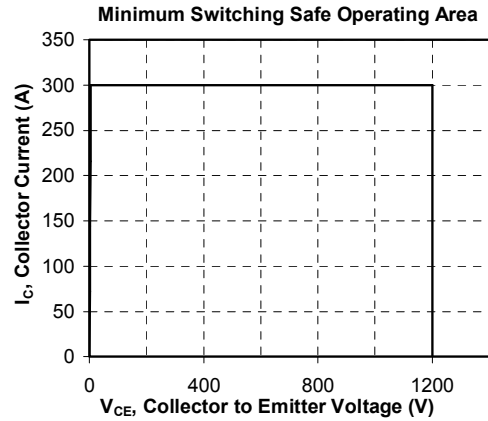
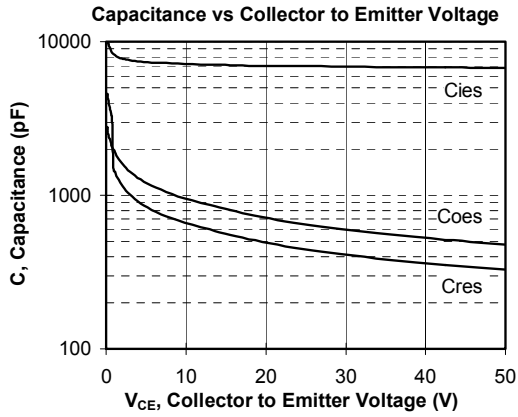
## Package outline



## Typical Performance Curve







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